

2022 / 2023 Tower Semiconductor MPW Schedule

	Fab		Tape-In	Ship Date
SB*18 B5007	NPB - Fab 3	SiGe BiCMOS 0.18um	06/14/22	12/20/22
<i>Please contact your sales representative for information on fast track processing.</i>				
SB*18 B5009	NPB - Fab 3	SiGe BiCMOS 0.18um	08/09/22	02/14/23
<i>Please contact your sales representative for information on fast track processing.</i>				
22nd MPW Tonami, Japan	TPSCo - Fab 5	TS18 CMOS 0.18u & 0.16u, PM, PM_SOI	08/29/22	
SB*/CA/13* B5011	NPB - Fab 3	SiGe BiCMOS / RF CMOS 0.13um	08/30/22	04/26/23
<i>Please contact your sales representative for information on fast track processing.</i>				
PH18DAZ B5008	NPB - Fab 3	SiPho 0.18um	08/30/22	03/03/23
CA18 B5012	NPB - Fab 3	RFCMOS 0.18um	09/13/22	02/21/23
<i>Please contact your sales representative for information on fast track processing.</i>				
CS18* B5010	MH - Fab 2	CMOS-SOI 0.18um	09/20/22	
22nd MPW Uozu, Japan	TPSCo - Fab 7	CMOS, PM & RFCMOS 65nm : TPS65SLA/SLC, TPS65PMA/PMB/MSA/MSB, TPS65RF	09/26/22	
SB*18 B5013	NPB - Fab 3	SiGe BiCMOS 0.18um	10/04/22	04/11/23
<i>Please contact your sales representative for information on fast track processing.</i>				
23rd MPW Uozu, Japan	TPSCo - Fab 7	RFSOI 65nm: TPS90RSB2, TPS65RSA2/RSB	10/17/22	
PH18M* B5014	NPB - Fab 3	SiPho 0.18um	11/01/22	03/17/23

2022 / 2023 Tower Semiconductor MPW Schedule

	Fab		Tape-In	Ship Date
PH18DAZ B5258	NPB - Fab 3	SiPho 0.18um	11/08/22	05/12/23
SH422T18NOV	MH - Fab 2	CIS 0.18um Image Sensor	11/14/22	
		CMOS+ 0.16um, 0.18um RF, RFID, PM	11/21/22	
23rd MPW Tonami, Japan	TPSCo - Fab 5	TS18	11/28/22	
		CMOS 0.18u & 0.16u, PM, PM_SOI		
SB*18 B5015	NPB - Fab 3	SiGe BiCMOS 0.18um	12/06/22	06/13/23
	<i>Please contact your sales representative for information on fast track processing.</i>			
24th MPW Uozu, Japan	TPSCo - Fab 7	RFSOI, 65nm :	01/10/23	
		TPS90RSB2, TPS65RSA2/RSB/RSB2		
CA18 B5300	NPB - Fab 3	RFCMOS 0.18um	01/24/23	07/07/23
	<i>Please contact your sales representative for information on fast track processing.</i>			
SB*18 B5301	NPB - Fab 3	SiGe BiCMOS 0.18um	02/07/23	08/17/23
	<i>Please contact your sales representative for information on fast track processing.</i>			
SH123T18FEB	MH - Fab 2	0.18 BSI, Stacking on 0.13	02/14/23	
PH18M* B5302	NPB - Fab 3	SiPho 0.18um	02/21/23	07/07/23
24th MPW Tonami, Japan	TPSCo - Fab 5	TS18	02/27/23	
		CMOS 0.18u & 0.16u, PM, PM_SOI		
SB*/CA/13* B5303	NPB - Fab 3	SiGe BiCMOS / RF CMOS 0.13um	03/07/23	11/03/23
	<i>Please contact your sales representative for information on fast track processing.</i>			
25th MPW Uozu, Japan	TPSCo - Fab 7	CMOS,PM & RFCMOS, 65nm :	03/20/23	
		TPS65SLA/SLC, TPS65PMA/PMB/MSA/MSB, TPS65RF		

2022 / 2023 Tower Semiconductor MPW Schedule

	Fab		Tape-In	Ship Date
PH18DAZ B5304	NPB - Fab 3	SiPho 0.18um	03/21/23	09/22/23
SB*18 B5305	NPB - Fab 3	SiGe BiCMOS 0.18um	04/04/23	10/10/23
<i>Please contact your sales representative for information on fast track processing.</i>				
CS18* B5306	MH - Fab 2	CMOS-SOI 0.18um	05/02/23	
CA18 B5307	NPB - Fab 3	RFCMOS 0.18um	05/16/23	10/27/23
<i>Please contact your sales representative for information on fast track processing.</i>				
SH223T18MAY	MH - Fab 2	CIS 0.18um Image Sensor	05/16/23	
		CMOS+ 0.16um, 0.18um RF, RFID, PM	05/23/23	
25th MPW Tonami, Japan	TPSCo - Fab 5	TS18	05/29/23	
		CMOS 0.18u & 0.16u, PM, PM_SOI		
PH18M* B5308	NPB - Fab 3	SiPho 0.18um	05/30/23	10/13/23
SB*18 B5309	NPB - Fab 3	SiGe BiCMOS 0.18um	06/06/23	12/14/23
<i>Please contact your sales representative for information on fast track processing.</i>				
SB*/CA/13* B5310	NPB - Fab 3	SiGe BiCMOS / RF CMOS 0.13um	06/20/23	02/16/24
<i>Please contact your sales representative for information on fast track processing.</i>				
SB*18 B5311	NPB - Fab 3	SiGe BiCMOS 0.18um	08/01/23	02/08/24
<i>Please contact your sales representative for information on fast track processing.</i>				
SH323T18AUG	MH - Fab 2	CIS 0.18um Image Sensor	08/08/23	
		CMOS+ 0.16um, 0.18um RF, RFID, PM	08/15/23	
26th MPW Tonami, Japan	TPSCo - Fab 5	TS18	08/28/23	
		CMOS 0.18u & 0.16u, PM, PM_SOI		

2022 / 2023 Tower Semiconductor MPW Schedule

	Fab		Tape-In	Ship Date
PH18M* B5312	NPB - Fab 3	SiPho 0.18um	08/29/23	01/12/24
CS18* B5313	MH - Fab 2	CMOS-SOI 0.18um	09/12/23	
26th MPW Uozu, Japan	TPSCo - Fab 7	CMOS,PM & RFCMOS, 65nm : TPS65SLA/SLC, TPS65PMA/PMB/MSA/MSB, TPS65RF	09/25/23	
SB*18 B5314	NPB - Fab 3	SiGe BiCMOS 0.18um	09/26/23	04/04/24
<i>Please contact your sales representative for information on fast track processing.</i>				
PH18DAZ B5315	NPB - Fab 3	SiPho 0.18um	10/10/23	04/12/24
27th MPW Uozu, Japan	TPSCo - Fab 7	RFSOI, 65nm : TPS90RSB2, TPS65RSA2/RSB/RSB2	10/16/23	
CA18 B5317	NPB - Fab 3	RFCMOS 0.18um	11/07/23	04/19/24
<i>Please contact your sales representative for information on fast track processing.</i>				
SH423T18NOV	MH - Fab 2	CIS 0.18um Image Sensor CMOS+ 0.16um, 0.18um RF, RFID, PM	11/14/23 11/21/23	
27th MPW Tonami, Japan	TPSCo - Fab 5	TS18 CMOS 0.18u & 0.16u, PM, PM_SOI	11/27/23	
PH18M* B5318	NPB - Fab 3	SiPho 0.18um	11/28/23	04/12/24
SB*18 B5319	NPB - Fab 3	SiGe BiCMOS 0.18um	12/12/23	06/21/24
<i>Please contact your sales representative for information on fast track processing.</i>				

2022 / 2023 Tower Semiconductor MPW Schedule

	Fab		Tape-In	Ship Date
--	-----	--	---------	-----------

Notes : "Shuttles" (SH*) are run at Fab 2

* 0.13u MH - fab 2 Shuttle / MPW slots will be considered per needs

Please contact your customer account manager for additional information.

Fab2 -- Tower Semiconductor 200mm wafer fabrication facility at Migdal Ha'emek, Israel

Fab3 -- Tower Semiconductor 200mm wafer fabrication facility at Newport Beach, CA

Fab5 -- Tower Semiconductor 200mm wafer fabrication facility at Tonami, Japan

Fab7 -- Tower Semiconductor 300mm wafer fabrication facility at Uozu, Japan